















ESD

TVS

MOS

LDO

Diode

Sensor

DC-DC

Product Specification

Domestic Part Number	AO4485
Overseas Part Number	AO4485
▶ Equivalent Part Number	AO4485





General Description

The AO4485 uses advanced trench technology to provide excellent $R_{\text{DS(ON)}}$ with low gate charge. This device is suitable for use as a DC-DC converter application.

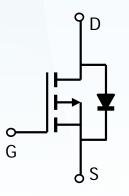
Features

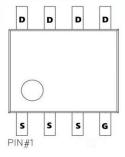
 $V_{DS}(V) = -40V$

 $I_{D} = -10A$

 $R_{DS(ON)} < 15 m\Omega \qquad (V_{GS} = -10 V)$

 $R_{DS(ON)} < 20m\Omega$ (V_{GS} = -4.5V)





Absolute Maximum Ratings T_J=25°C unless otherwise noted

Parameter		Symbol	10 Sec	Steady State	Units	
Drain-Source Voltage		V_{DS}	V _{DS} -40		V	
Gate-Source Voltage		V_{GS}	±20		V	
Continuous Drain	T _A =25°C		-12	-10		
Current ^A	T _A =70°C	I _D	-9	-8	Δ	
Pulsed Drain Current ^B		I _{DM}	-120		Α	
Avalanche Current ^G		I _{AR}	-28			
Repetitive avalanche energy L=0.3mH ^G		E _{AR}	118		mJ	
Power Dissipation ^A	T _A =25°C	$-P_{D}$	3.1	1.7	W	
	T _A =70°C	' D	2.0	1.1	VV	
Junction and Storage Temperature Range		T_J , T_{STG}	-55 1	to 150	°C	

Thermal Characteristics

Parameter		Symbol	Тур	Max	Units
Maximum Junction-to-Ambient A	t ≤ 10s	$R_{\scriptscriptstyle{ hetaJA}}$	31	40	°C/W
Maximum Junction-to-Ambient A	Steady State	IN _θ JA	59	75	°C/W
Maximum Junction-to-Lead ^C	Steady State	$R_{ heta JL}$	16	24	°C/W



Electrical Characteristics (T_J=25°C unless otherwise noted)

Symbol	Parameter	Conditions	Min	Тур	Max	Units
STATIC P	ARAMETERS					
BV _{DSS}	Drain-Source Breakdown Voltage	$I_D = -250 \mu A, V_{GS} = 0 V$	-40			V
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = -40V, V_{GS} = 0V$ $T_{J} = 55^{\circ}C$			-1 -5	μА
I _{GSS}	Gate-Body leakage current	$V_{DS} = 0V, V_{GS} = \pm 20V$			±100	nA
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS} I_{D} = -250 \mu A$	-1	-1.5	-2.5	V
I _{D(ON)}	On state drain current	$V_{GS} = -10V, V_{DS} = -5V$	-120			Α
R _{DS(ON)}	Static Drain-Source On-Resistance	$V_{GS} = -10V, I_D = -10A$		12.5	15	mΩ
		$V_{GS} = -4.5V, I_D = -8A$		16	20	
g _{FS}	Forward Transconductance	$V_{DS} = -5V, I_{D} = -10A$		25		S
V_{SD}	Diode Forward Voltage	$I_S = -1A, V_{GS} = 0V$		-0.7	-1	V
Is	Maximum Body-Diode Continuous Curr	rent			-3	Α
DYNAMIC	PARAMETERS				-	
C _{iss}	Input Capacitance			2500	3000	pF
C _{oss}	Output Capacitance	V_{GS} =0V, V_{DS} =-20V, f=1MHz		260		pF
C _{rss}	Reverse Transfer Capacitance	1		180		pF
R_g	Gate resistance	V _{GS} =0V, V _{DS} =0V, f=1MHz	2.5	4	6	Ω
SWITCHII	NG PARAMETERS					
Q _g (10V)	Total Gate Charge			42	55	nC
Q _g (4.5V)	Total Gate Charge	V _{GS} =-10V, V _{DS} =-20V, I _D =-10A		18.6		nC
Q_{gs}	Gate Source Charge	GS=-10V, VDS=-20V, ID=-10A		7		nC
Q_{gd}	Gate Drain Charge			8.6		nC
t _{D(on)}	Turn-On DelayTime			9.4		ns
t _r	Turn-On Rise Time	V_{GS} =-10V, V_{DS} =-20V,		20		ns
t _{D(off)}	Turn-Off DelayTime	$R_L = 2\Omega, R_{GEN} = 3\Omega$		55		ns
t _f	Turn-Off Fall Time			30		ns
t _{rr}	Body Diode Reverse Recovery Time	I _F =-10A, dI/dt=100A/μs		38	49	ns
Q_{rr}	Body Diode Reverse Recovery Charge	I _F =-10A, dI/dt=100A/μs		47		nC

A: The value of R $_{\theta,JA}$ is measured with the device mounted on 1in 2 FR-4 board with 2oz. Copper, in a still air environment with T $_A$ = 25°C. The value in any given application depends on the user's specific board design.

B: Repetitive rating, pulse width limited by junction temperature.

C. The R $_{\theta JA}$ is the sum of the thermal impedence from junction to lead R $_{\theta JL}$ and lead to ambient.

D. The static characteristics in Figures 1 to 6 are obtained using $t \leqslant 300 \mu s$ pulses, duty cycle 0.5% max.

E. These tests are performed with the device mounted on 1 in 2 FR-4 board with 2oz. Copper, in a still air environment with T_A =25°C. The SOA curve provides a single pulse rating.

F. The current rating is based on the $t \leqslant 10 s$ thermal resistance rating.

G. E_{AR} and I_{AR} ratings are based on low frequency and duty cycles to keep $T_{j} \! = \! 25 \text{C}.$



TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

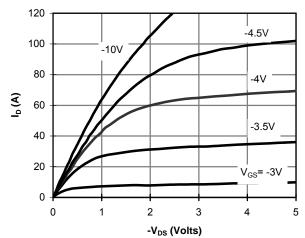


Figure 1: On-Region Characteristics

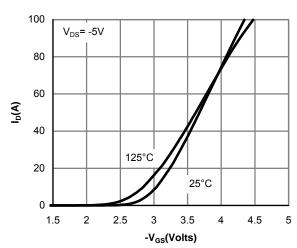


Figure 2: Transfer Characteristics

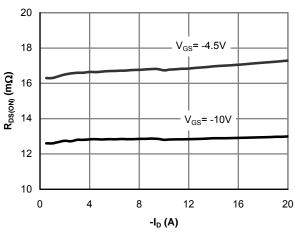


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

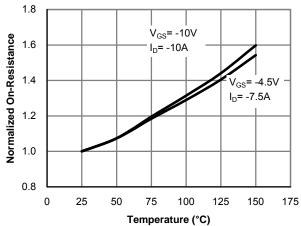


Figure 4: On-Resistance vs. Junction Temperature

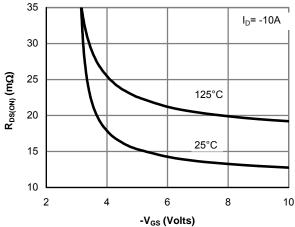


Figure 5: On-Resistance vs. Gate-Source Voltage

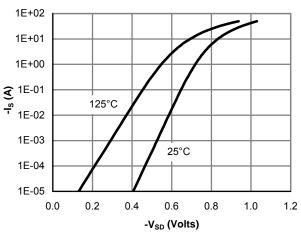
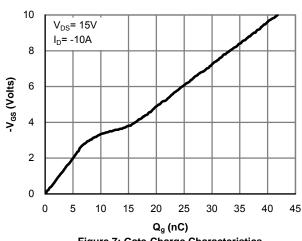


Figure 6: Body-Diode Characteristics



TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS



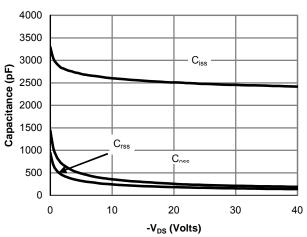
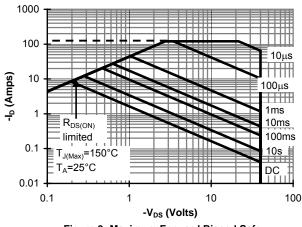


Figure 7: Gate-Charge Characteristics

Figure 8: Capacitance Characteristics



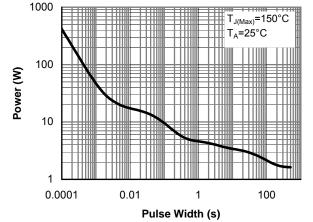


Figure 9: Maximum Forward Biased Safe Operating Area (Note E)

Figure 10: Single Pulse Power Rating Junctionto-Ambient (Note E)

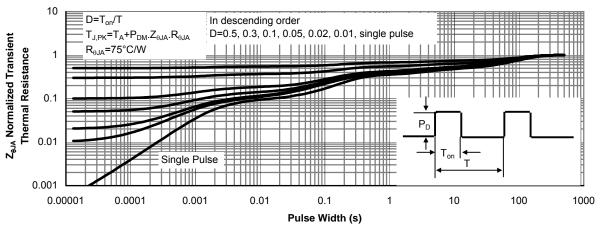
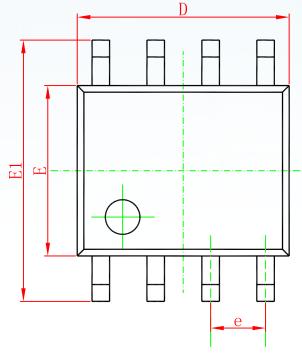


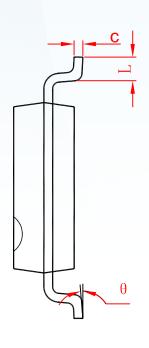
Figure 11: Normalized Maximum Transient Thermal Impedance(Note E)

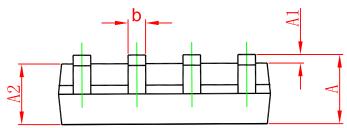


PACKAGE OUTLINE DIMENSIONS





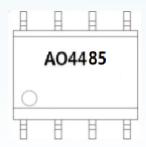




Cymhal	Dimensions In Millimeters		Dimensions In Inches		
Symbol	Min	Max	Min	Max	
А	1.350	1.750	0.053	0.069	
A1	0.100	0.250	0.004	0.010	
A2	1.350	1.550	0.053	0.061	
b	0.330	0.510	0.013	0.020	
С	0.170	0.250	0.006	0.010	
D	4.700	5.100	0.185	0.200	
Е	3.800	4.000	0.150	0.157	
E1	5.800	6.200	0.228	0.244	
е	1.270(BSC)		0.050	O(BSC)	
L	0.400	1.270	0.016	0.050	
θ	0°	8°	0°	8°	



Marking



Ordering information

Order code	Package	Baseqty	Deliverymode
AO4485	SOP-8	3000	Tape and reel



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